TPS7B69xx-Q1 High-Voltage Ultra-Low I_Q Low-Dropout Regulator

1 Features

- Qualified for Automotive Applications
- AEC-Q100 Qualified With the Following Results:
  - Device Temperature Grade 1: –40°C to 125°C Ambient Operating Temperature Range
  - Device HBM ESD Classification Level 2
  - Device CDM ESD Classification Level C4B
- 4 to 40-V Wide V_I Input Voltage Range With up to 45-V Transient
- Maximum Output Current: 150 mA
- Low Quiescent Current (I_Q):
  - 15 µA Typical at Light Loads
  - 25 µA Maximum Under Full Temperature
- 450-mV Typical Low Dropout Voltage at 100 mA Load Current
- Stable With Low ESR Ceramic Output Capacitor (2.2 to 100 µF)
- Fixed 2.5-V, 3.3-V, and 5-V Output Voltage Options
- Integrated Fault Protection:
  - Thermal Shutdown
  - Short-Circuit Protection
- Packages:
  - 4-Pin SOT-223 Package
  - 5-Pin SOT-23 Package

2 Applications

- Automotive
- Infotainment Systems With Sleep Mode
- Always-On Battery Applications
  - Door Modules
  - Remote Keyless-Entry Systems
  - Immobilizers

3 Description

The TPS7B69xx-Q1 device is a low-dropout linear regulator designed for up to 40-V V_I operations. With only 15-µA (typical) quiescent current at light load, the device is suitable for standby microcontrol-unit systems especially in automotive applications.

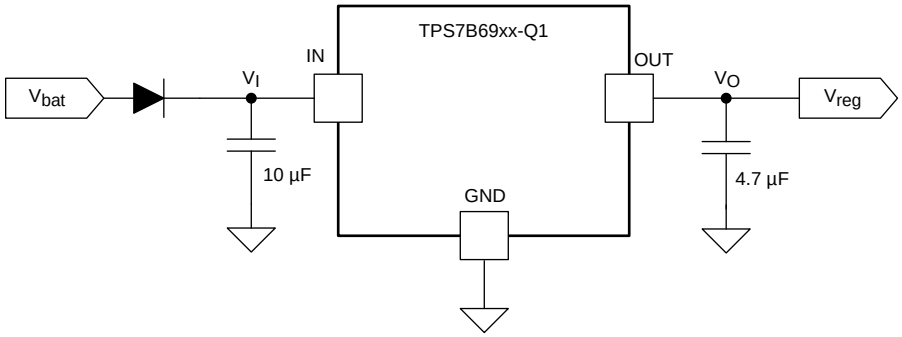
The devices feature an integrated short-circuit and overcurrent protection. The TPS7B69xx-Q1 device operates over a –40°C to 125°C temperature range. Because of these features, the TPS7B6925-Q1, TPS7B6933-Q1, and TPS7B6950-Q1 devices are well suited in power supplies for various automotive applications.

Device Information(1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TPS7B6925-Q1	SOT-223 (4)	6.50 mm × 3.50 mm
TPS7B6933-Q1 TPS7B6950-Q1	SOT-23 (5)	2.90 mm × 1.60 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

4 Typical Application Schematic



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

Table of Contents

1 Features ... 1
2 Applications ... 1
3 Description ... 1
4 Typical Application Schematic ... 1
5 Revision History ... 2
6 Pin Configuration and Functions ... 3
7 Specifications ... 4
7.1 Absolute Maximum Ratings ... 4
7.2 ESD Ratings ... 4
7.3 Recommended Operating Conditions ... 4
7.4 Thermal Information ... 4
7.5 Electrical Characteristics ... 5
7.6 Typical Characteristics ... 6
8 Detailed Description ... 10
8.1 Overview ... 10
8.2 Functional Block Diagram ... 10
8.3 Feature Description ... 10
8.4 Device Functional Modes ... 11
9 Application and Implementation ... 12
9.1 Application Information ... 12
9.2 Typical Application ... 12
10 Power Supply Recommendations ... 14
11 Layout ... 14
11.1 Layout Guidelines ... 14
11.2 Layout Example ... 14
12 Device and Documentation Support ... 15
12.1 Documentation Support ... 15
12.2 Related Links ... 15
12.3 Trademarks ... 15
12.4 Electrostatic Discharge Caution ... 15
12.5 Glossary ... 15
13 Mechanical, Packaging, and Orderable Information ... 15

5 Revision History

Changes from Revision A (December 2014) to Revision B **Page**

- Changed the TPS7B6933-Q1 device status from *Product Preview* to *Production Data* ... 1
- Added the TPS7B6933-Q1 device test results to the *Typical Characteristics* section ... 6

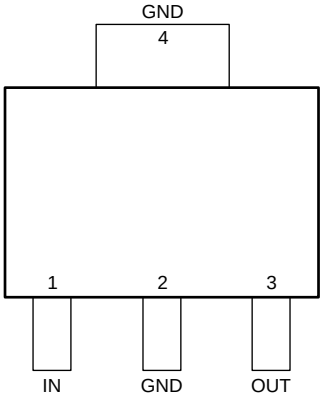
Changes from Original (November 2014) to Revision A **Page**

- Changed the device status from *Product Preview* to *Production Data* ... 1

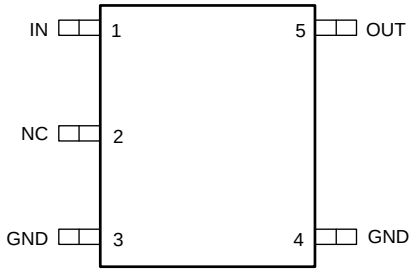
Copyright © 2014–2015, Texas Instruments Incorporated

6 Pin Configuration and Functions

DCY Package
4-Pin SOT-223
Top View



DBV Package
5-Pin SOT-23
Top View



NC - No internal connection

Pin Functions

PIN			TYPE	DESCRIPTION
NAME	NO.			
	SOT-223	SOT-23		
GND	2	3	G	Ground reference
	4	4		
IN	1	1	P	Input power-supply voltage
NC	—	2	—	Not connected pin
OUT	3	5	P	Output voltage

Copyright © 2014–2015, Texas Instruments Incorporated

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
Unregulated input voltage	IN(2)(3)(4)	–0.3	45	V
Regulated output voltage	OUT(2)(3)	–0.3	7	V
Operating junction temperature range, T_J		–40	150	°C
Storage temperature, T_{stg}		–65	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) All voltage values are with respect to the GND terminal.
(3) Absolute negative voltage on these pins must not to go below –0.3 V.
(4) Absolute maximum voltage, withstands 45 V for 200 ms.

7.2 ESD Ratings

				VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per AEC Q100-002(1)		±2000	V
		Charged device model (CDM), per AEC Q100-011	Other pins	±500	
			Corner pins (4 pin: 1, 3, and 4; 5 pin: 1, 3, 4, and 5)	±750	

(1) AEC Q100-002 indicates HBM stressing is done in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_I	Unregulated input voltage	4	40	V
V_O	Output voltage	0	5.5	V
C_O	Output capacitor requirements(1)	2.2	100	µF
ESR_{CO}	Output ESR requirements(2)	0.001	2	Ω
T_J	Operating junction temperature range	–40	150	°C

(1) The output capacitance range specified in this table is the effective value.
(2) Relevant ESR value at f = 10 kHz.

7.4 Thermal Information

THERMAL METRIC(1)(2)		DCY 4 PINS	DBV 5 PINS	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	64.2	210.4	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	46.8	126.1	
$R_{\theta JB}$	Junction-to-board thermal resistance	13.3	38.4	
ψ_{JT}	Junction-to-top characterization parameter	6.3	16	
ψ_{JB}	Junction-to-board characterization parameter	13.2	37.5	

(1) The thermal data is based on the JEDEC standard high-K profile, JESD 51-7, 2s2p four layer board with 2-oz copper. The copper pad is soldered to the thermal land pattern. Also correct attachment procedure must be incorporated.
(2) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, SPRA953.

Copyright © 2014–2015, Texas Instruments Incorporated

7.5 Electrical Characteristics

V_{IN} = 14 V, 1 mΩ < ESR < 2 Ω, T_J = –40°C to 150 °C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
SUPPLY VOLTAGE AND CURRENT (IN)						
V_I	Input voltage	Fixed 2.5-V output, I_O = 1 mA	4		40	V
		Fixed 3.3-V output, I_O = 1 mA	4		40	
		Fixed 5-V output, I_O = 1 mA	5.5		40	
I_Q	Quiescent current	Fixed 2.5-V and 3.3-V version, V_I = 4 to 40 V, Fixed 5-V version, V_I = 5.5 to 40 V, I_O = 0.2 mA		15	25	µA
$V_{IN(UVLO)}$	IN undervoltage detection	Ramp V_I up until the output turns on	3.65			V
		Ramp V_I down until the output turns OFF			3	
REGULATED OUTPUT (OUT)						
V_O	Regulated output	Fixed 2.5-V version, V_I = 4 to 40 V, I_O = 1 to 150 mA	–3%		3%	
		Fixed 3.3-V version, V_I = 5 to 40 V, I_O = 1 to 150 mA	–3%		3%	
		Fixed 5-V version, V_I = 6.5 to 40 V, I_O = 1 to 150 mA	–3%		3%	
$\Delta V_{O(\Delta VI)}$	Line regulation	V_I = 6 to 40 V, ΔV_O, I_O = 10 mA			10	mV
$\Delta V_{O(\Delta IL)}$	Load regulation	I_O = 1 to 150 mA, ΔV_O			20	mV
V_{DROP}	Dropout voltage	Fixed 2.5-V version, $V_I – V_O$, I_O = 50 mA			1.575	V
		Fixed 2.5-V version, $V_I – V_O$, I_O = 100 mA			1.575	
		Fixed 3.3-V version, $V_I – V_O$, I_O = 50 mA			799	mV
		Fixed 3.3-V version, $V_I – V_O$, I_O = 100 mA			800	
		Fixed 5-V version, $V_I – V_O$, I_O = 50 mA		220	400	
		Fixed 5-V version, $V_I – V_O$, I_O = 100 mA		450	800	
I_O	Output current	V_O in regulation	0		150	mA
I_{OCL}	Output current-limit	OUT short to ground	150		500	mA
PSRR	Power supply ripple rejection(1)	V_{rip} = 0.5 V_{pp}, Load = 10 mA, f = 100 Hz, C_O = 2.2 µF		60		dB
OPERATING TEMPERATURE RANGE						
T_{sd}	Junction shutdown temperature			175		°C
T_{hys}	Hysteresis of thermal shutdown			25		°C

(1) Design Information—Not tested, ensured by characterization.

Copyright © 2014–2015, Texas Instruments Incorporated

7.6 Typical Characteristics

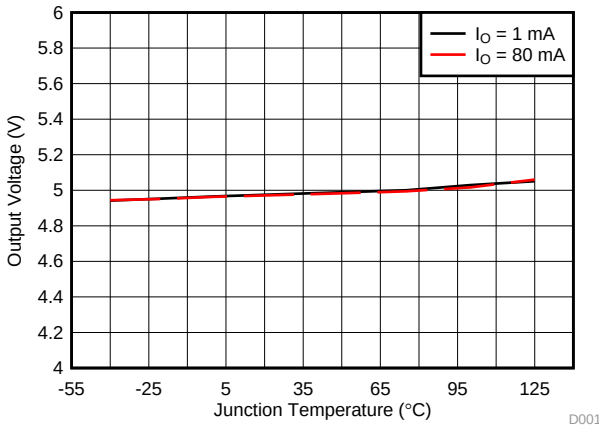


Figure 1. 5-V Output Voltage vs Junction Temperature

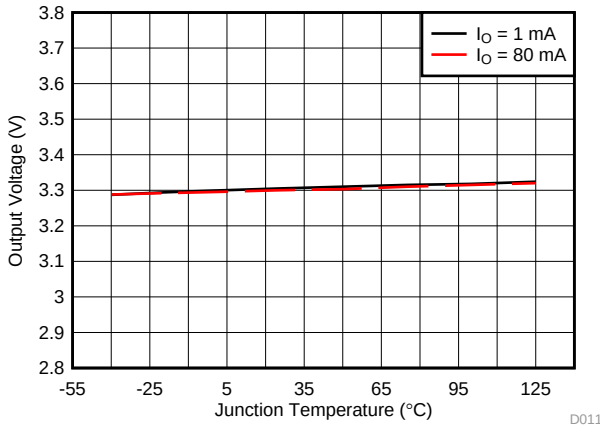


Figure 2. 3.3-V Output Voltage vs Junction Temperature

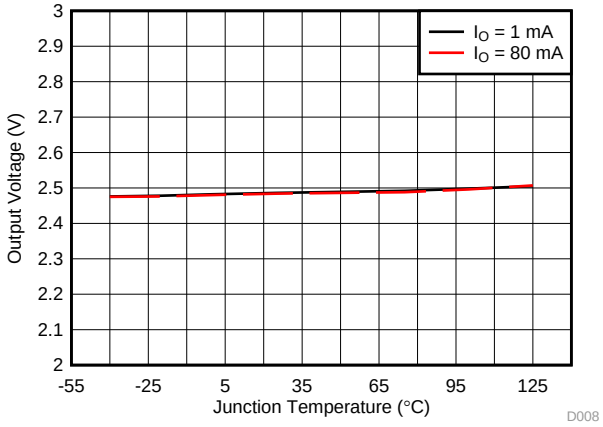


Figure 3. 2.5-V Output Voltage vs Junction Temperature

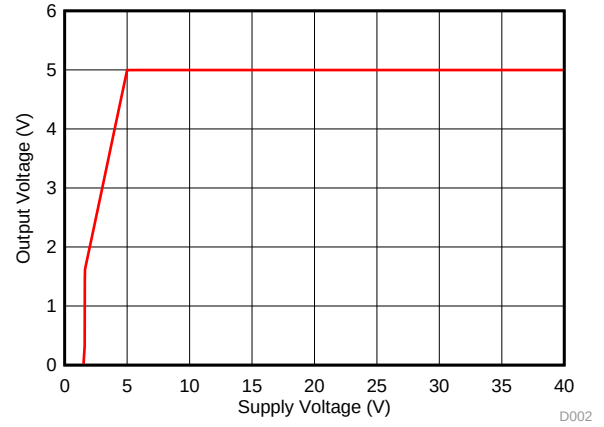


Figure 4. 5-V Output Voltage vs Supply Voltage

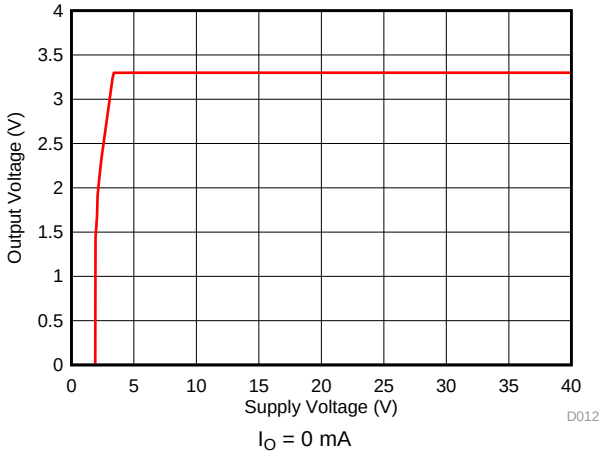


Figure 5. 3.3-V Output Voltage vs Supply Voltage

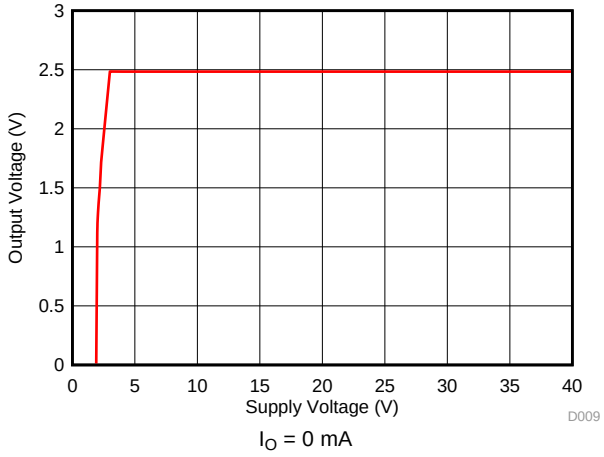


Figure 6. 2.5-V Output Voltage vs Supply Voltage

Copyright © 2014–2015, Texas Instruments Incorporated

Typical Characteristics (continued)

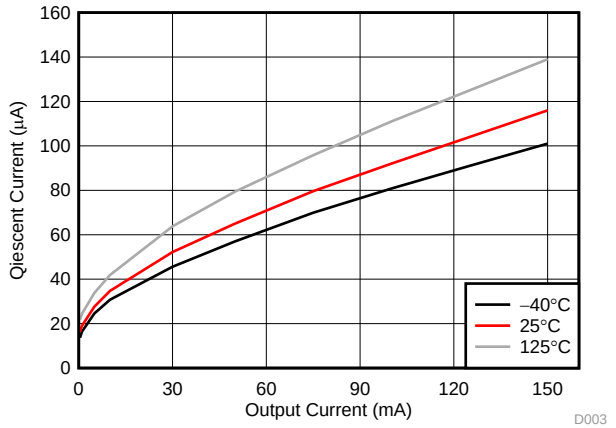
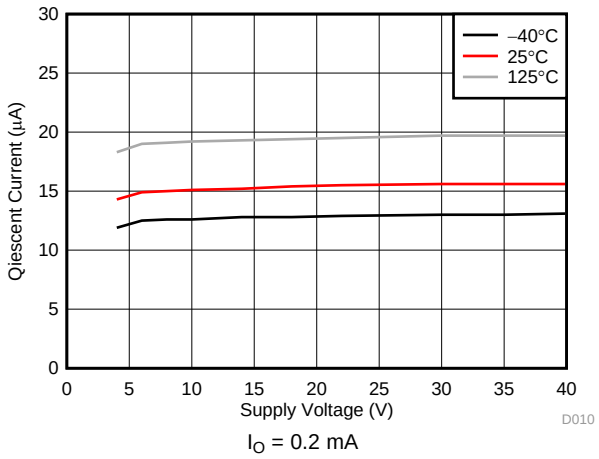


Figure 7. Quiescent Current vs Output Current



I_O = 0.2 mA

Figure 8. Quiescent Current vs Supply Voltage

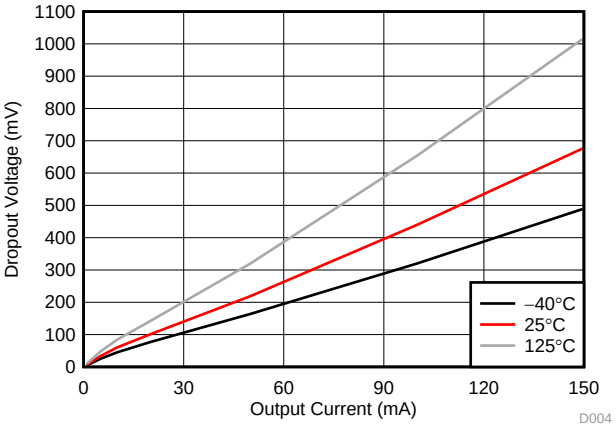
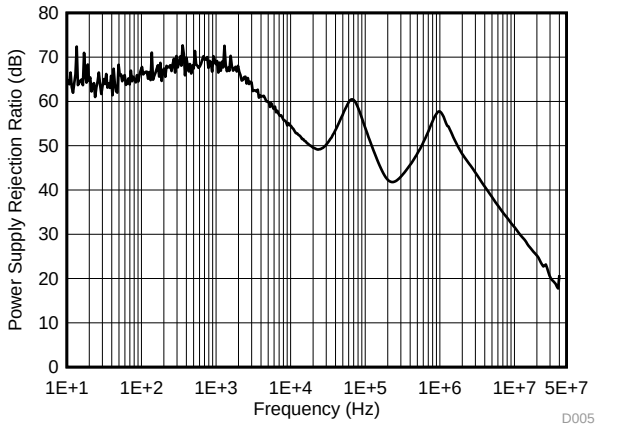
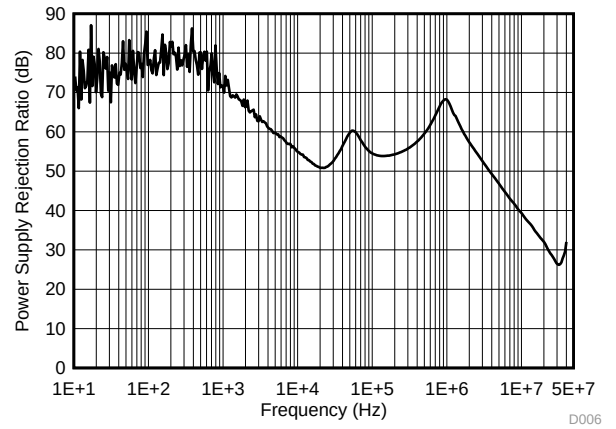


Figure 9. Dropout Voltage vs Output Current



I_O = 100 mA V_I = 14 V T_A = 25°C
C_O = 2.2 µF

Figure 10. Power Supply Rejection Ratio



I_O = 10 mA V_I = 14 V T_A = 25°C
C_O = 2.2 µF

Figure 11. Power Supply Rejection Ratio

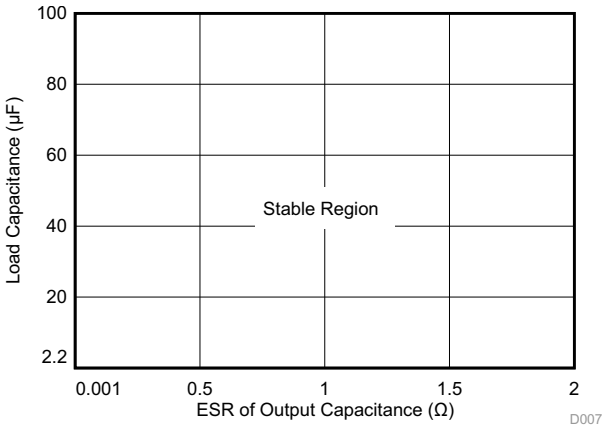
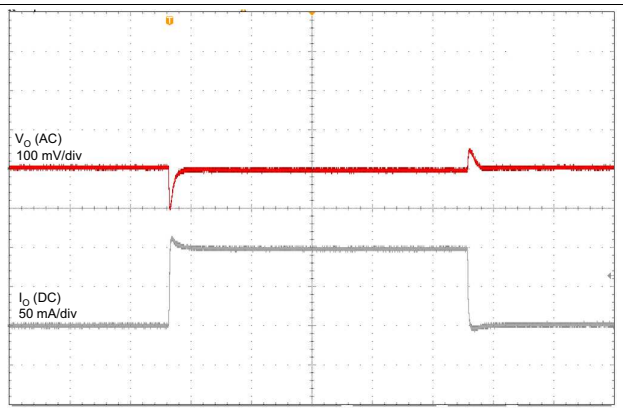


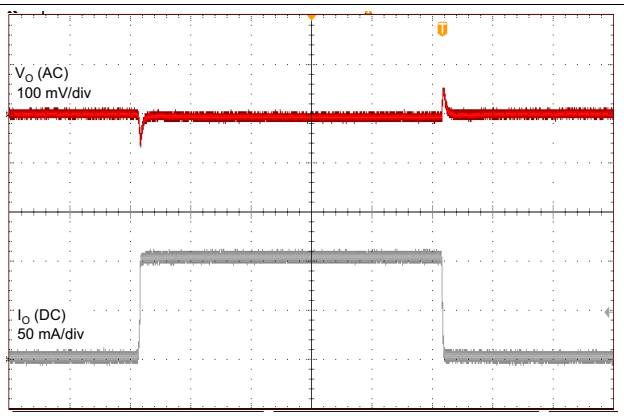
Figure 12. ESR Stability vs Output Capacitance

Typical Characteristics (continued)



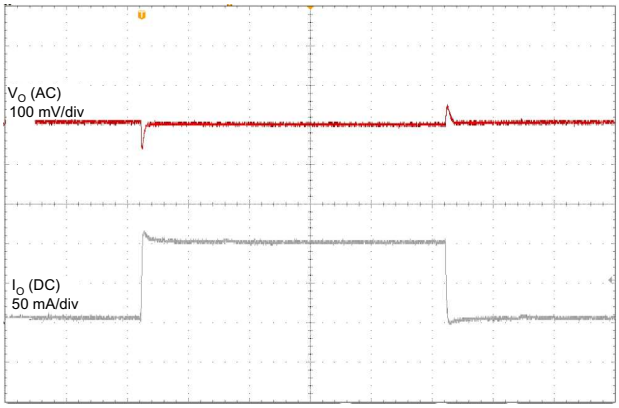
V_I = 14 V C_O = 2.2 µF 1 ms/div
V_O = 5 V

Figure 13. Load Transient (1 to 100 mA, 5 V)



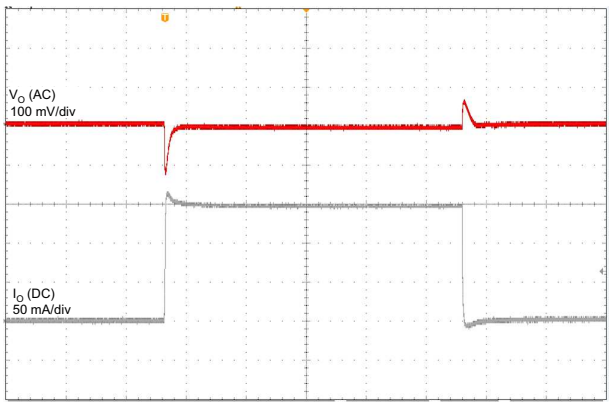
V_I = 14 V C_O = 2.2 µF 1 ms/div
V_O = 3.3 V

Figure 14. Load Transient (1 to 100 mA, 3.3 V)



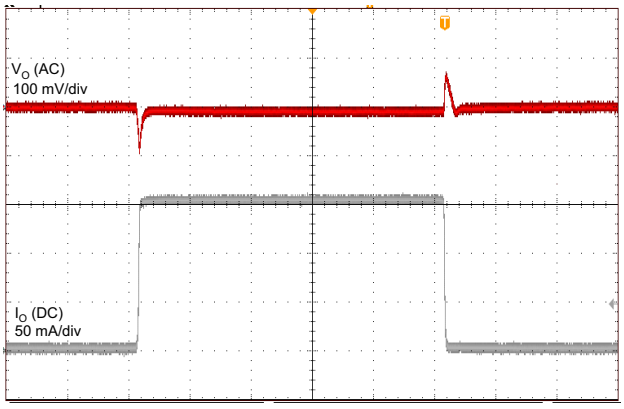
V_I = 14 V C_O = 2.2 µF 1 ms/div
V_O = 2.5 V

Figure 15. Load Transient (1 to 100 mA, 2.5 V)



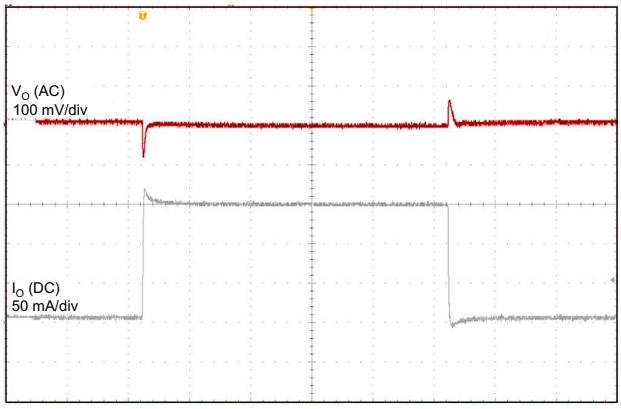
V_I = 14 V C_O = 2.2 µF 1 ms/div
V_O = 5 V

Figure 16. Load Transient (1 to 150 mA, 5 V)



V_I = 14 V C_O = 2.2 µF 1 ms/div
V_O = 3.3 V

Figure 17. Load Transient (1 to 150 mA, 3.3 V)



V_I = 14 V C_O = 2.2 µF 1 ms/div
V_O = 2.5 V

Figure 18. Load Transient (1 to 150 mA, 2.5 V)

Copyright © 2014–2015, Texas Instruments Incorporated

Typical Characteristics (continued)

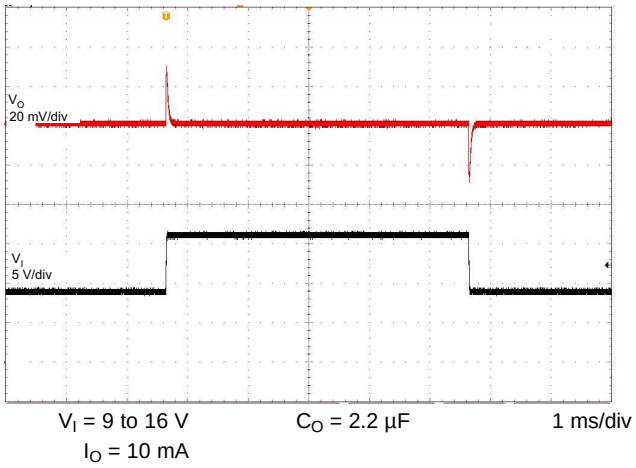


Figure 19. Line Transient (V_O = 5 V)

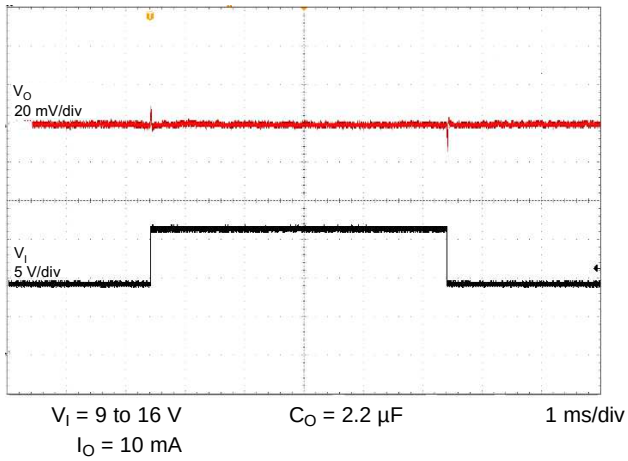


Figure 20. Line Transient (V_O = 3.3 V)

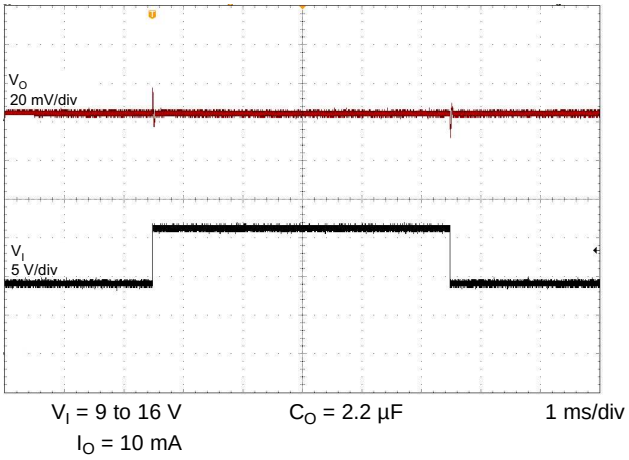


Figure 21. Line Transient (V_O = 2.5 V)

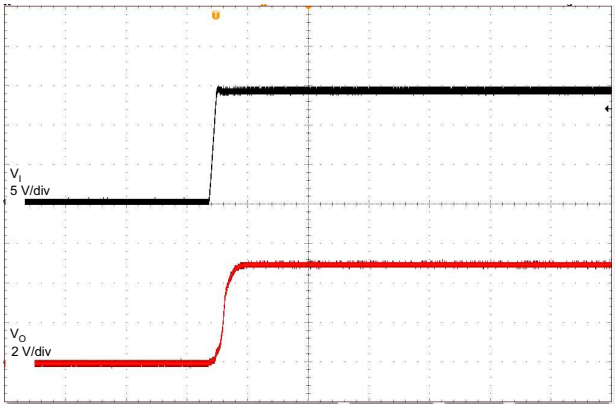


Figure 22. 5-V Power Up

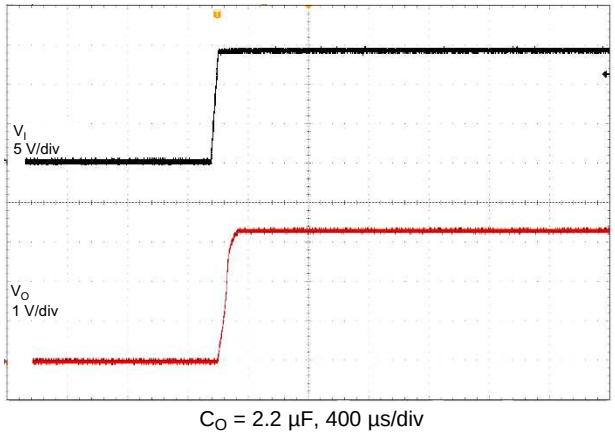


Figure 23. 3.3-V Power Up

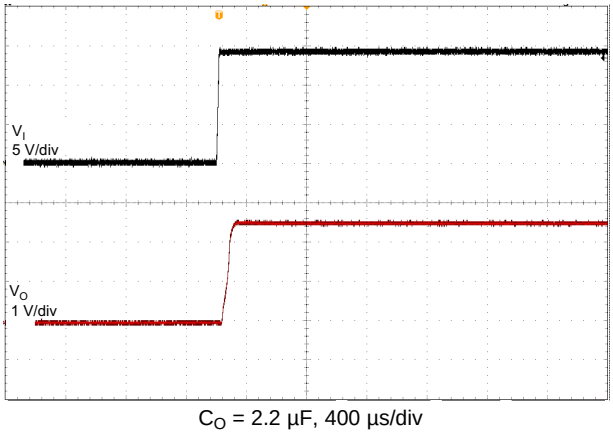


Figure 24. 2.5-V Power Up

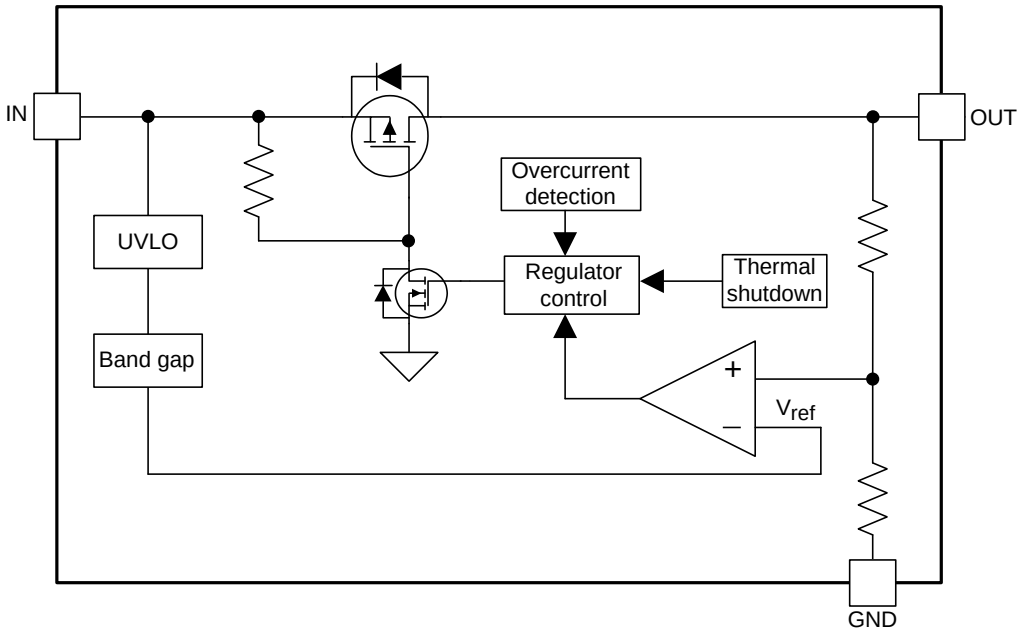
Copyright © 2014–2015, Texas Instruments Incorporated

8 Detailed Description

8.1 Overview

The TPS7B69xx-Q1 high-voltage linear regulator operates over a 4-V to 40-V input voltage range. The device has an output current capability of 150 mA and offers fixed output voltages of 2.5 V (TPS7B6925-Q1), 3.3 V (TPS7B6933-Q1) or 5 V (TPS7B6950-Q1). The device features a thermal shutdown and short-circuit protection to prevent damage during over-temperature and overcurrent conditions.

8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 Input (IN)

The IN pin is a high-voltage-tolerant pin. A capacitor with a value higher than 0.1 µF is recommended to be connected close to this pin to better the transient performance.

8.3.2 Output (OUT)

The OUT pin is the regulated output based on the required voltage. The output has current limitation. During the initial power up, the regulator has a soft start incorporated to control the initial current through the pass element and the output capacitor.

In the event that the regulator drops out of regulation, the output tracks the input minus a drop based on the load current. When the input voltage drops below the UVLO threshold, the regulator shuts down until the input voltage recovers above the minimum startup level.

8.3.3 Output Capacitor Selection

For stable operation over the full temperature range and with load currents up to 150 mA, use a capacitor with an effective value between 2.2 µF and 100 µF and ESR smaller than 2 Ω. To better the load transient performance, an output capacitor, such as a ceramic capacitor with low ESR, is recommended.

8.3.4 Low-Voltage Tracking

At low input voltages, the regulator drops out of regulation and the output voltage tracks input minus a voltage based on the load current (I_L) and switch resistor. This tracking allows for a smaller input capacitor and can possibly eliminate the need for a boost converter during cold-crank conditions.

Copyright © 2014–2015, Texas Instruments Incorporated

Feature Description (continued)

8.3.5 Thermal Shutdown

The TPS7B69xx-Q1 family of devices incorporates a thermal-shutdown (TSD) circuit as a protection from overheating. For continuous normal operation, the junction temperature should not exceed the TSD trip point. If the junction temperature exceeds the TSD trip point, the output turns off. When the junction temperature falls below the TSD trip point minus the hysteresis of TSD, the output turns on again. This cycling limits the dissipation of the regulator, protecting it from damage as a result of overheating.

The purpose of the design of the internal protection circuitry of the TPS7B69xx-Q1 family of devices is for protection against overload conditions, not as a replacement for proper heat-sinking. Continuously running the TPS7B69xx-Q1 family of devices into thermal shutdown degrades device reliability.

8.4 Device Functional Modes

8.4.1 Operation With V_I Less Than 4 V

The TPS7B69xx-Q1 family of devices operates with input voltages above 4 V. The maximum UVLO voltage is 3 V and the device operates at an input voltage above 4 V. The device can also operate at lower input voltages; no minimum UVLO voltage is specified. At input voltages below the actual UVLO, the device shuts down.

8.4.2 Operation With V_I Greater Than 4 V

When V_I is greater than 4 V, if the input voltage is higher than V_O plus the dropout voltage, the output voltage is equal to the set value. Otherwise, the output voltage is equal to V_I minus the dropout voltage.

Copyright © 2014–2015, Texas Instruments Incorporated

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The TPS7B69xx-Q1 family of devices is a 150-mA low-dropout linear regulator designed for up to 40-V V_I operation with only 15-µA quiescent current at light loads. Use the PSpice transient model to evaluate the base function of the device. To download the PSpice transient model, go to the device product folder on www.TI.com. In addition to this model, specific evaluation modules (EVM) are available for these devices. For the EVM and the EVM user guide, go to the device product folder.

9.2 Typical Application

Figure 25 shows the typical application circuit for the TPS7B69xx-Q1 family of devices. Based on the end-application, different values of external components can be used. An application can require a larger output capacitor during fast load steps to achieve better load transient response. TI recommends a low-ESR ceramic capacitor with a dielectric of type X5R or X7R for better load transient response.

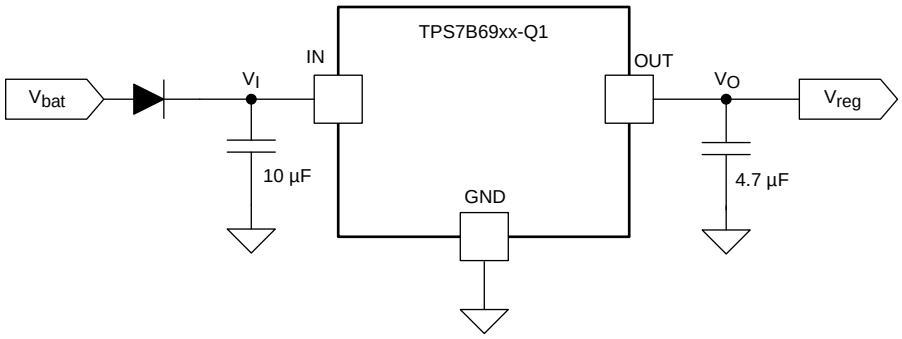


Figure 25. Typical Application Schematic for TPS7B69xx-Q1

9.2.1 Design Requirements

For this design example, use the parameters listed in Table 1.

Table 1. Design Parameters

DESIGN PARAMETER	EXAMPLE VALUES
Input voltage range	4 to 40 V
Output voltage	2.5 V, 3.3 V, 5 V
Output current rating	150 mA
Output capacitor range	2.2 to 100 µF
Output capacitor ESR range	1 mΩ to 2 Ω

9.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
- Output Voltage
- Output current rating

Copyright © 2014–2015, Texas Instruments Incorporated

9.2.2.1 Input Capacitor

The device requires an input decoupling capacitor, the value of which depends on the application. The typical recommend value for the decoupling capacitor is higher than 0.1 µF. The voltage rating must be greater than the maximum input voltage.

9.2.2.2 Output Capacitor

The device requires an output capacitor to stabilize the output voltage. The output capacitor value should be between 2.2 µF and 100 µF. The ESR value range should be between 1 mΩ and 2 Ω. TI recommends a ceramic capacitor with low ESR to improve the load transient response.

9.2.2.3 Power Dissipation and Thermal Considerations

Use Equation 1 to calculate the power dissipated in the device.

$$P_D = I_O \times (V_I - V_O) + I_Q \times V_I \quad (1)$$

where

- P_D = continuous power dissipation
- I_O = output current
- V_I = input voltage
- V_O = output voltage

Because I_Q « I_O, the term $I_Q \times V_I$ in Equation 1 can be ignored.

For a device under operation at a given ambient air temperature (T_A), use Equation 2 to calculate the junction temperature (T_J).

$$T_J = T_A + (Z_{\theta JA} \times P_D) \quad (2)$$

where

- $Z_{\theta JA}$ = junction-to-ambient air thermal impedance

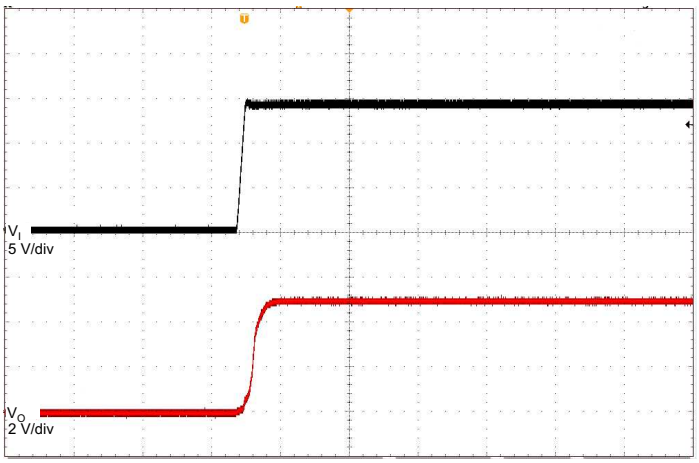
Use Equation 3 to calculate the rise in junction temperature because of power dissipation.

$$\Delta T = T_J - T_A = (Z_{\theta JA} \times P_D) \quad (3)$$

For a given maximum junction temperature (T_{Jmax}), use Equation 4 to calculate the maximum ambient air temperature (T_{Amax}) at which the device can operate.

$$T_{Amax} = T_{Jmax} - (Z_{\theta JA} \times P_D) \quad (4)$$

9.2.3 Application Curve



C_O = 2.2 µF, 400 µs/div

Figure 26. Power Up (5 V)

10 Power Supply Recommendations

The device is designed to operate from an input-voltage supply range between 4 V and 40 V. This input supply must be well regulated. If the input supply is located more than a few inches from the TPS7B69xx-Q1 device, TI recommends adding an electrolytic capacitor with a value of 10 µF and a ceramic bypass capacitor at the input.

11 Layout

11.1 Layout Guidelines

For the layout of TPS7B69xx-Q1 family of devices, place the input and output capacitors close to the devices as shown in Figure 27 and Figure 28. To enhance the thermal performance, TI recommends surrounding the device with some vias.

Minimize equivalent series inductance (ESL) and ESR to maximize performance and ensure stability. Place every capacitor as close as possible to the device and on the same side of the PCB as the regulator.

Do not place any of the capacitors on the opposite side of the PCB from where the regulator is installed. TI strongly discourages the use of long traces because they can impact system performance negatively and even cause instability.

If possible, and to ensure the maximum performance specified in this product data sheet, use the same layout pattern used for the TPS7B69xx-Q1 evaluation board.

11.2 Layout Example

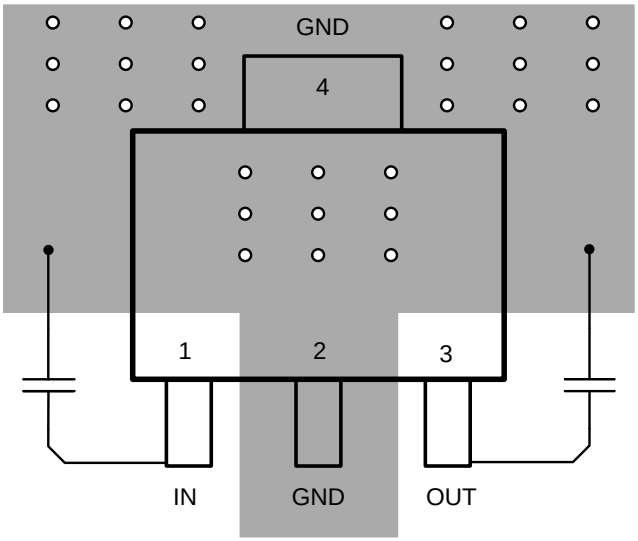


Figure 27. Layout Example for SOT-223 Package

Copyright © 2014–2015, Texas Instruments Incorporated

Layout Example (continued)

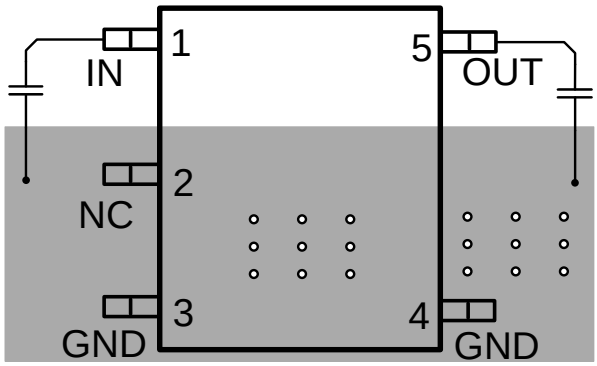


Figure 28. Layout Example for SOT-23 Package

12 Device and Documentation Support

12.1 Documentation Support

12.1.1 Related Documentation

For related documentation see the following:

TPS7B6950EVM User's Guide, SLVUAC0.

12.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

Table 2. Related Links

PARTS	PRODUCT FOLDER	SAMPLE & BUY	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY
TPS7B6925-Q1	Click here	Click here	Click here	Click here	Click here
TPS7B6933-Q1	Click here	Click here	Click here	Click here	Click here
TPS7B6950-Q1	Click here	Click here	Click here	Click here	Click here

12.3 Trademarks

All trademarks are the property of their respective owners.

12.4 Electrostatic Discharge Caution

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.5 Glossary

SLYZ022 — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Copyright © 2014–2015, Texas Instruments Incorporated

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS7B6925QDBVRQ1	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	ZBE2
TPS7B6925QDBVRQ1.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	ZBE2
TPS7B6925QDCYRQ1	Active	Production	SOT-223 (DCY) | 4	2500 | LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 125	7B6925
TPS7B6925QDCYRQ1.A	Active	Production	SOT-223 (DCY) | 4	2500 | LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 125	7B6925
TPS7B6933QDBVRQ1	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	ZBF2
TPS7B6933QDBVRQ1.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	ZBF2
TPS7B6933QDCYRQ1	Active	Production	SOT-223 (DCY) | 4	2500 | LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 125	7B6933
TPS7B6933QDCYRQ1.A	Active	Production	SOT-223 (DCY) | 4	2500 | LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 125	7B6933
TPS7B6950QDBVRQ1	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	ZAZ2
TPS7B6950QDBVRQ1.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 125	ZAZ2
TPS7B6950QDCYRQ1	Active	Production	SOT-223 (DCY) | 4	2500 | LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 125	7B6950
TPS7B6950QDCYRQ1.A	Active	Production	SOT-223 (DCY) | 4	2500 | LARGE T&R	Yes	SN	Level-3-260C-168 HR	-40 to 125	7B6950

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TPS7B69-Q1 :

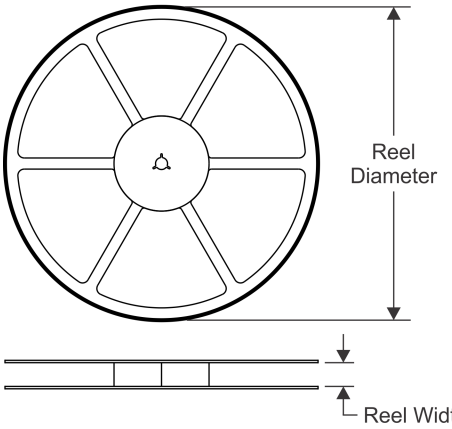
- Catalog : TPS7B69

NOTE: Qualified Version Definitions:

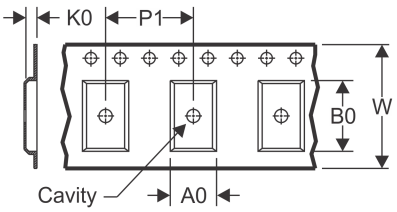
- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION

REEL DIMENSIONS

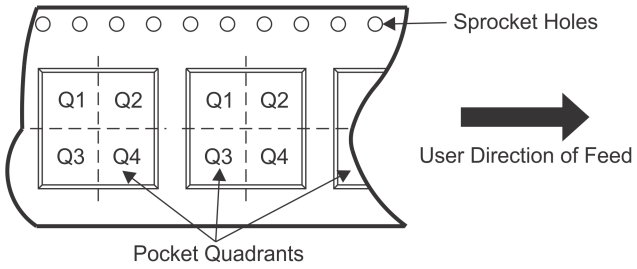


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

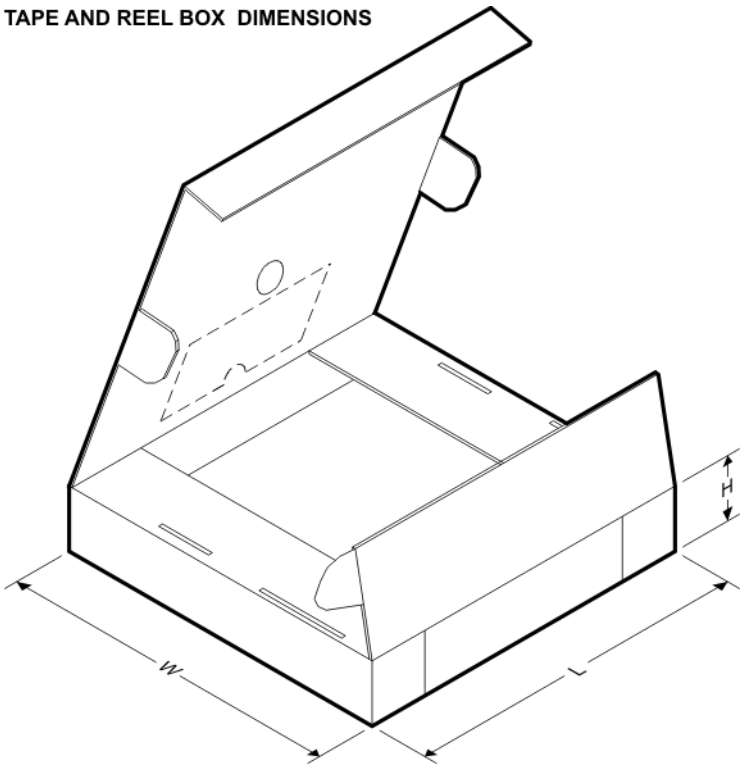
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS7B6925QDBVRQ1	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS7B6925QDCYRQ1	SOT-223	DCY	4	2500	330.0	12.4	7.05	7.4	1.9	8.0	12.0	Q3
TPS7B6933QDBVRQ1	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS7B6933QDCYRQ1	SOT-223	DCY	4	2500	330.0	12.4	7.05	7.4	1.9	8.0	12.0	Q3
TPS7B6950QDBVRQ1	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS7B6950QDCYRQ1	SOT-223	DCY	4	2500	330.0	12.4	7.05	7.4	1.9	8.0	12.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

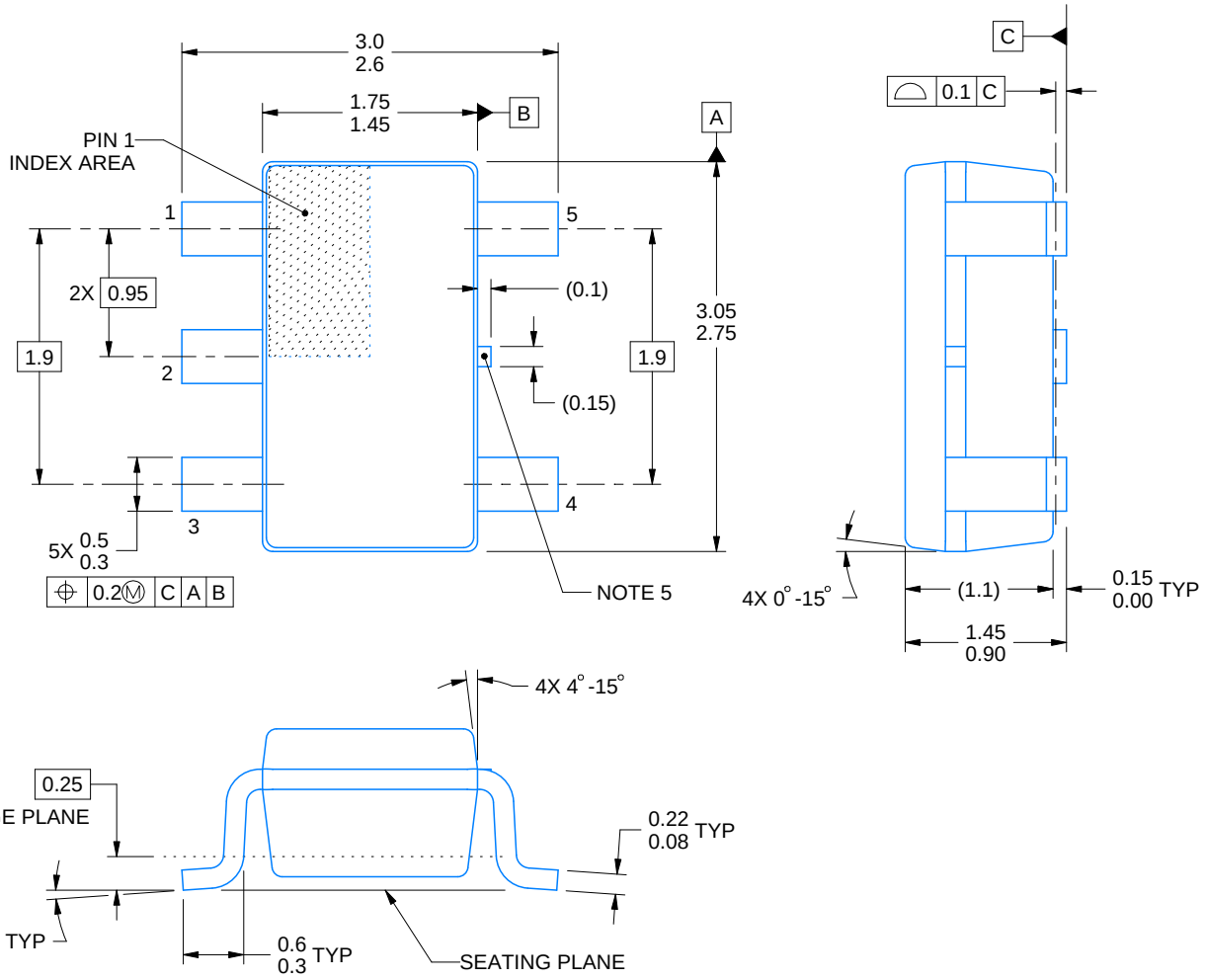
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS7B6925QDBVRQ1	SOT-23	DBV	5	3000	190.0	190.0	30.0
TPS7B6925QDCYRQ1	SOT-223	DCY	4	2500	340.0	340.0	38.0
TPS7B6933QDBVRQ1	SOT-23	DBV	5	3000	190.0	190.0	30.0
TPS7B6933QDCYRQ1	SOT-223	DCY	4	2500	340.0	340.0	38.0
TPS7B6950QDBVRQ1	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS7B6950QDCYRQ1	SOT-223	DCY	4	2500	340.0	340.0	38.0

PACKAGE OUTLINE

DBV0005A

SOT-23 - 1.45 mm max height

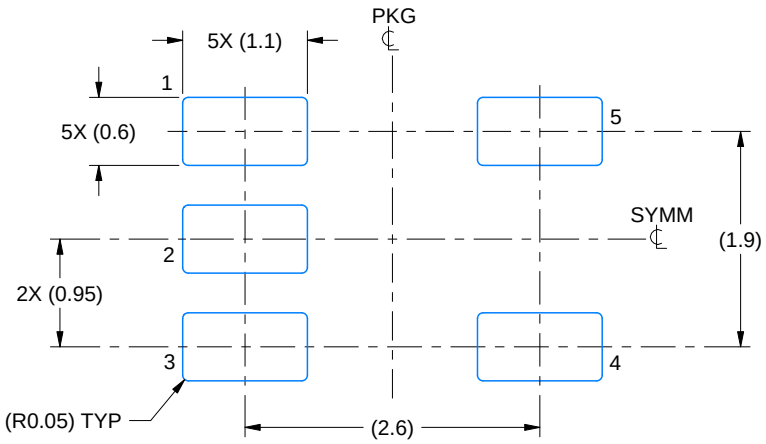
SMALL OUTLINE TRANSISTOR



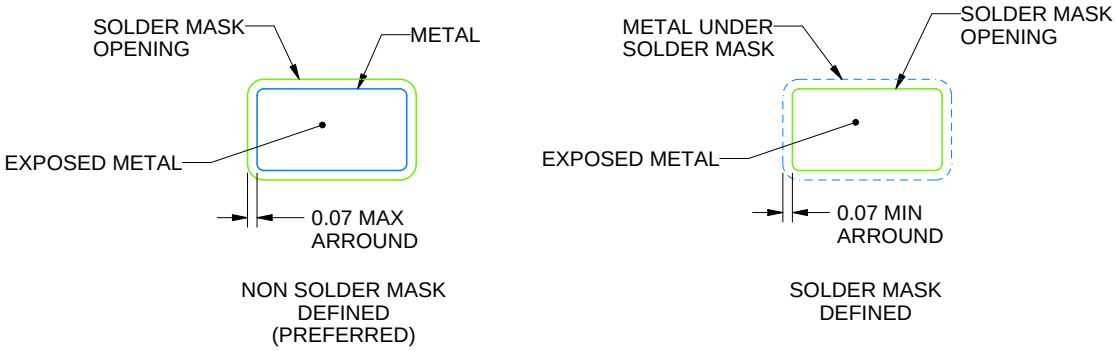
4214839/K 08/2024

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Refernce JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
5. Support pin may differ or may not be present.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X

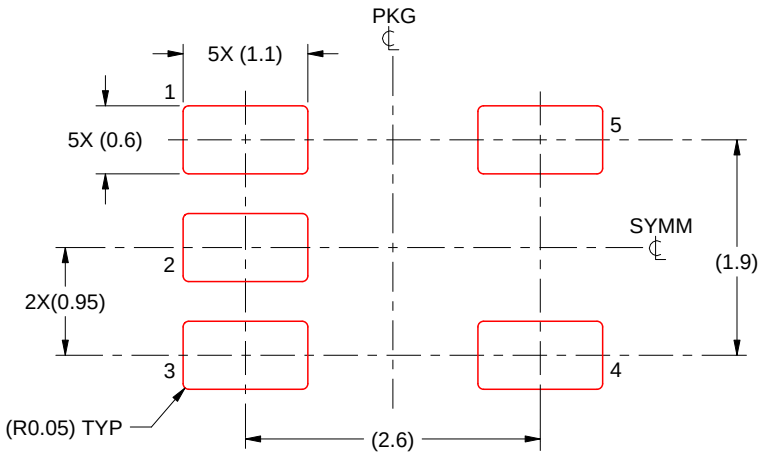


SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

4214839/K 08/2024

NOTES: (continued)

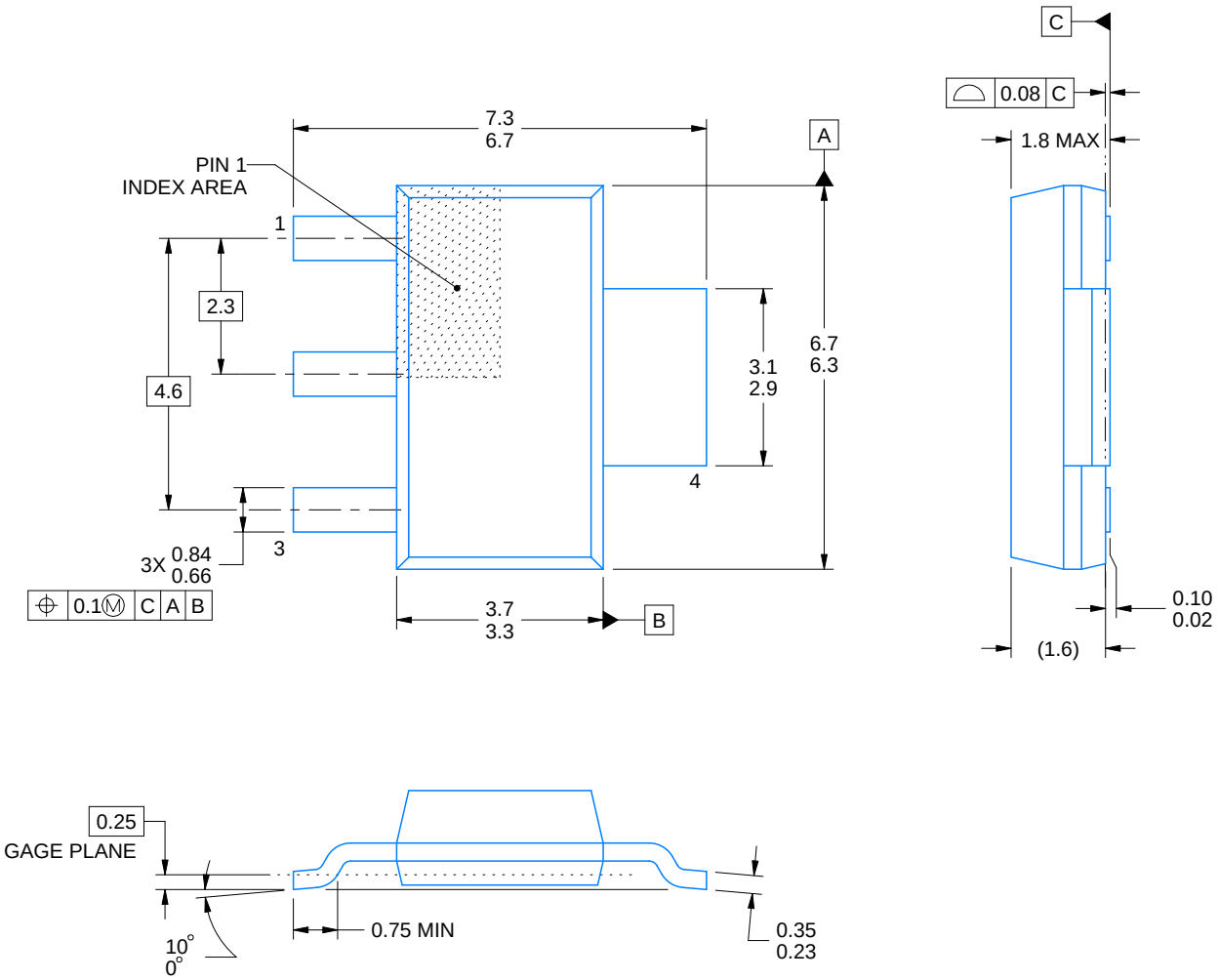
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

PACKAGE OUTLINE

DCY0004A

SOT-223 - 1.8 mm max height

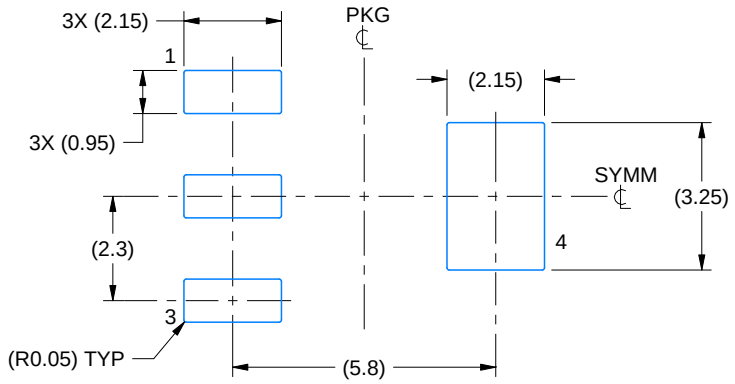
PLASTIC SMALL OUTLINE



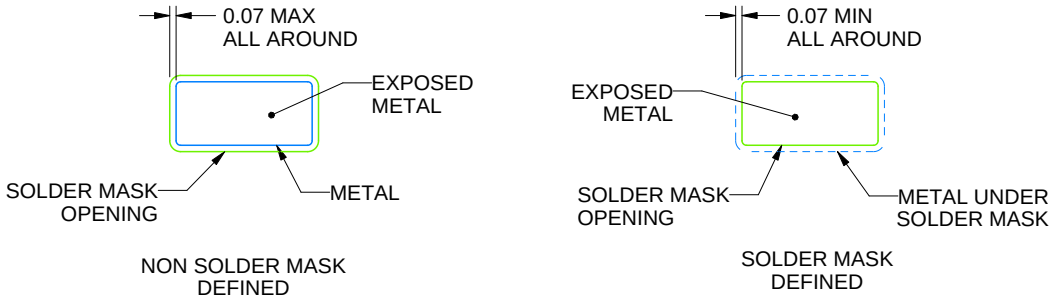
4214843/C 05/2026

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC TO-261.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X



SOLDER MASK DETAILS

4214843/C 05/2026

NOTES: (continued)

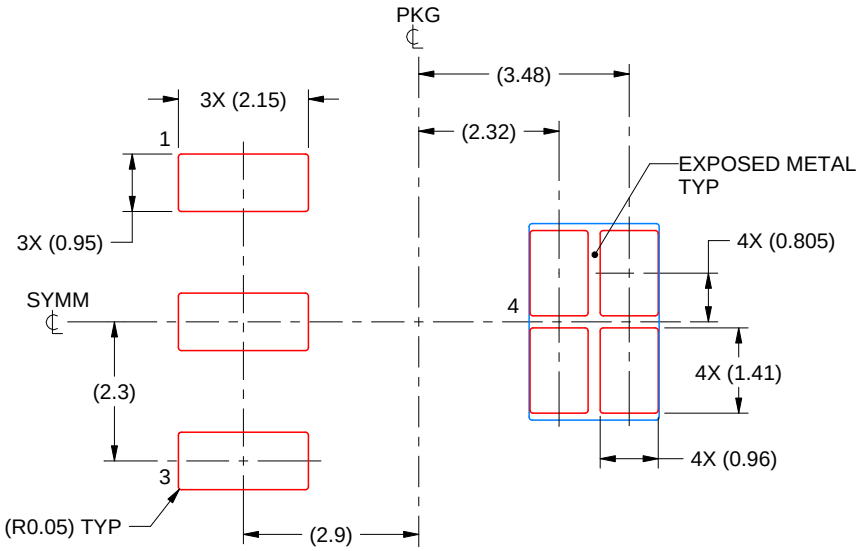
4. Publication IPC-7351 may have alternate designs.
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DCY0004A

SOT-223 - 1.8 mm max height

PLASTIC SMALL OUTLINE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:8X

4214843/C 05/2026

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES “AS IS” AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI’s products are provided subject to TI’s Terms of Sale, TI’s General Quality Guidelines, or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI’s provision of these resources does not expand or otherwise alter TI’s applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2026, Texas Instruments Incorporated

Last updated 10/2025

ENTEGRECİ

Bu belge www.entegreci.com üzerinden sunulmaktadır.

Elektronik komponent tedarikinde Entegreci

Entegreci, Eskişehir merkezli, Türkiye geneline satış yapan bir elektronik komponent mağazasıdır. Entegreler (IC), mikrodenetleyiciler, transistörler, diyotlar, pasif elemanlar, konnektörler, modüller ve geliştirme kartları tek adetten seri üretim adetlerine kadar satılır. Ürün sayfalarında güncel stok durumunu, fiyatı ve datasheet bağlantısını bulabilirsiniz.

Parça koduyla arama

Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

www.entegreci.com

Ürün kategorileri

Entegreden kapasitöre tüm elektronik komponent kategorileri.

Kategorilere göz atın

Üreticiler

Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

Üreticileri görün

Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

Teklif isteyin

www.entegreci.com | **destek@entegreci.com** | **0850 305 90 34**

Entegreci is an online electronic components store based in Türkiye. Search by manufacturer part number to see stock, prices and datasheets for integrated circuits, microcontrollers, transistors, passive components and connectors, or request a quote for parts that are not listed.

Bu sayfa Entegreci tarafından eklenmiştir. Belgenin önceki sayfaları asıl yayıncısına aittir ve içeriği değiştirilmemiştir; en güncel sürüm için belgenin yayıncısına başvurun.